

RoHS

COMPLIANT HALOGEN

FREE

Available

Vishay Siliconix

P-Channel 150 V (D-S) MOSFET

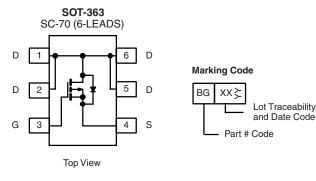
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 150	2.6 at V _{GS} = - 10 V	- 0.52	4.2 nC		
	2.7 at V _{GS} = - 6 V	- 0.51	4.2 110		

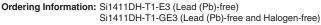
FEATURES

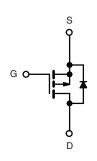
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFETS
- Small, Thermally Enhanced SC-70 Package
- Ultra Low On-Resistance
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Active Clamp Circuits in dc-to-dc Power Supplies







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	_A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 150		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _A = 25 °C	- I _D	- 0.52	- 0.42	
Continuous Drain Current $(T_j = 150 \text{ C})$	T _A = 85 °C		- 0.38	- 0.3	
Pulsed Drain Current		I _{DM}	- 0.8		А
Continuous Diode Current (Diode Conduction) ^a		۱ _S	- 1.3	- 0.83	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 2.1		
Single Pluse Avalanche Energy		E _{AS}	0.22		mJ
Movimum Dower Dissinction ⁸	T _A = 25 °C	D	1.56	1.0	W
Maximum Power Dissipation ^a	T _A = 85 °C	P _D	0.81	0.52	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \le 5 s$	R _{thJA}	60	80	
	Steady State		100	125	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	34	45	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -100 \ \mu A$			- 4.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA	
		V_{DS} = - 150 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}$	- 0.8			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} =$ - 10 V, I _D = - 0.5 A		2.05	2.6	Ω	
		V _{GS} = - 6 V, I _D = - 0.5 A		2.14	2.7		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 0.5 A		1.5		S	
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = - 1.4 A, $V_{\rm GS}$ = 0 V		- 0.80	- 1.1	V	
Dynamic ^b							
Total Gate Charge	Qg			4.2	6.3	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = - 75 V, V_{GS} = - 10 V, I_D = - 0.5 A		0.9			
Gate-Drain Charge	Q _{gd}			1.3			
Gate Resistance	R _g	f = 1.0 MHz		8.5		Ω	
Turn-On Delay Time	t _{d(on)}			4.5	7		
Rise Time	t _r	$V_{DD} = -75 \text{ V}, \text{ R}_{\text{I}} = 75 \Omega$		11	17	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 Å, V_{GEN} = - 4.5 V, R_g = 6 Ω		9	14		
Fall Time	t _f			11	17		
Reverse Recovery Time	t _{rr}			36	55		
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 0.5 A, dl/dt = 100 A/μs		65	100	nC	

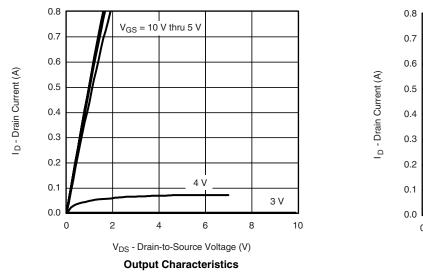
Notes:

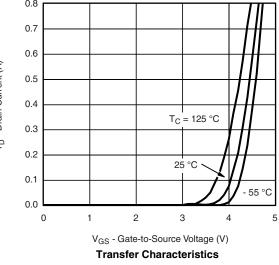
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

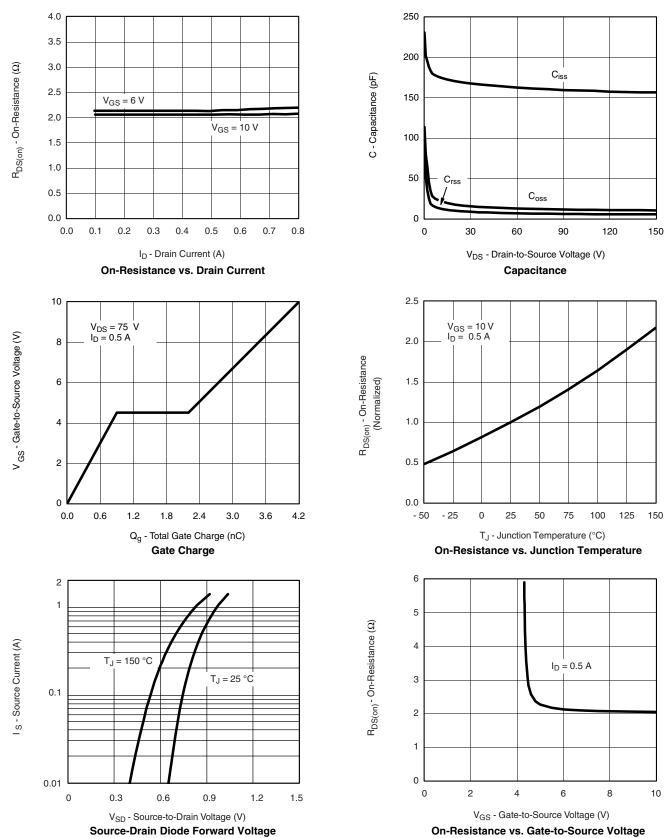






Si1411DH Vishay Siliconix

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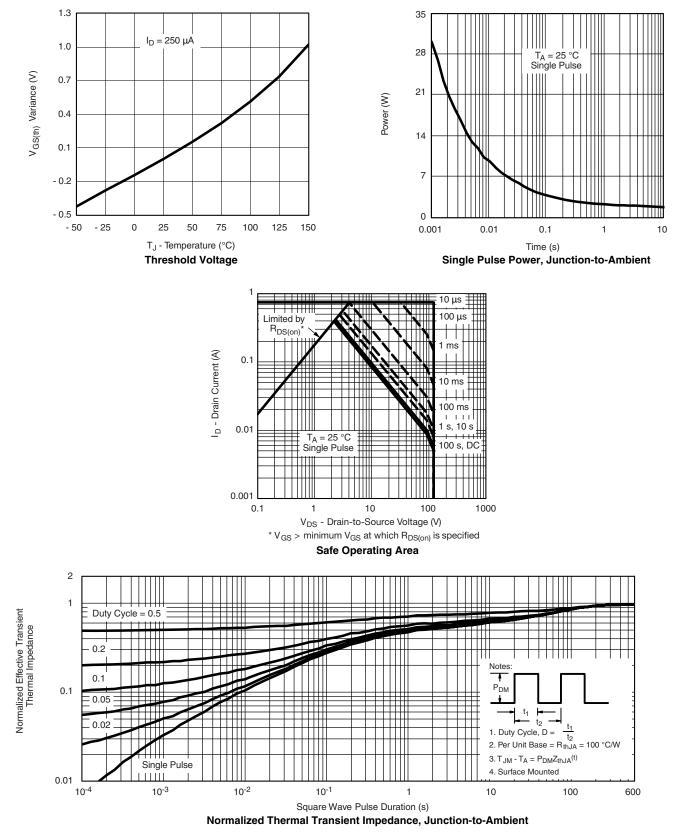


Si1411DH

Vishay Siliconix



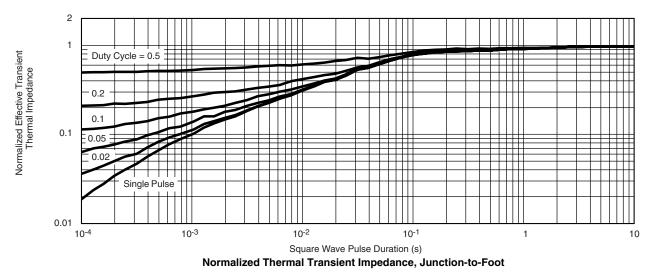
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73242.



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